



## NX8349TS,NX8349YK,NX8349XK

**Data Sheet** 

R08DS0002EJ0100 Rev.1.00 Jul 26, 2010

1 310 nm AlGainAs MQW-DFB LASER DIODE FOR 10 Gb/s APPLICATION

#### **DESCRIPTION**

LASER DIODE

The NX8349TS, NX8349YK, NX8349XK are 1 310 nm Multiple Quantum Wells (MQW) structured Distributed Feed-Back (DFB) laser diode TOSA (transmitter optical subassembly) with InGaAs monitor PIN-PD in a receptacle type package designed for SFP+/XFP transceiver.

### **FEATURES**

• Internal optical isolator

• Optical output power  $P_f = -3 \text{ dBm}$ 

• Low threshold current  $I_{th} = 8 \text{ mA TYP.} @ T_C = 25^{\circ}\text{C}$ 

Wide operating temperature range  $T_C = -5 \text{ to } +95^{\circ}\text{C}$ 

• InGaAs monitor PIN-PD

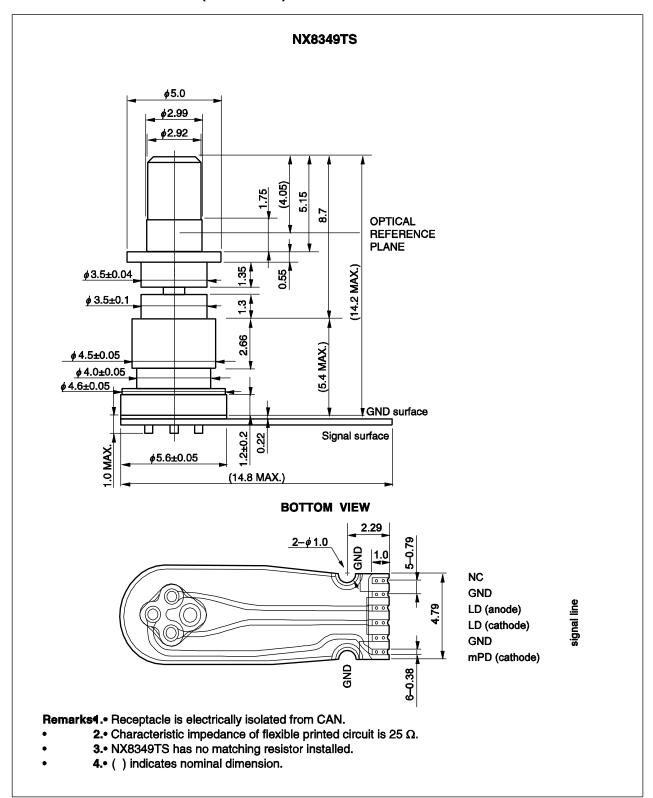
### **APPLICATIONS**

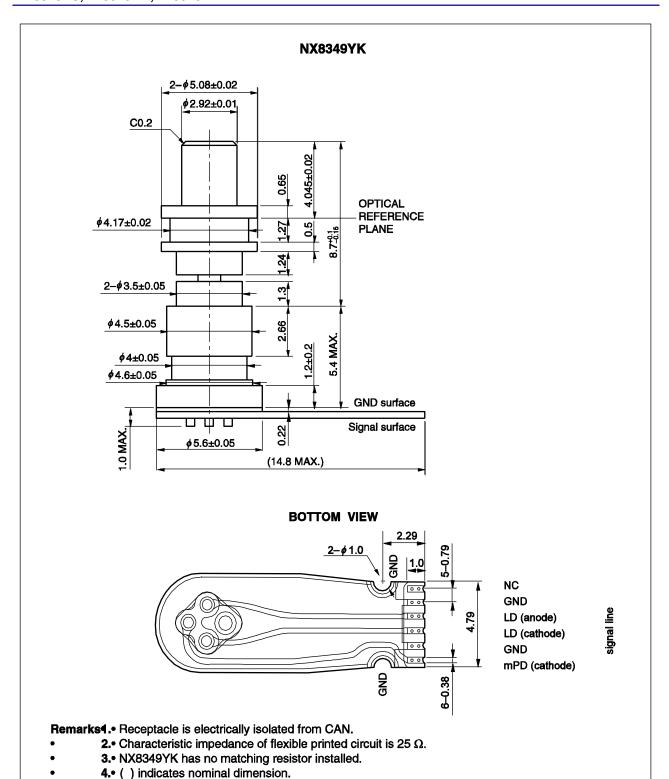
- 10 G BASE-LW/LR
- 10 G Fibre Channel

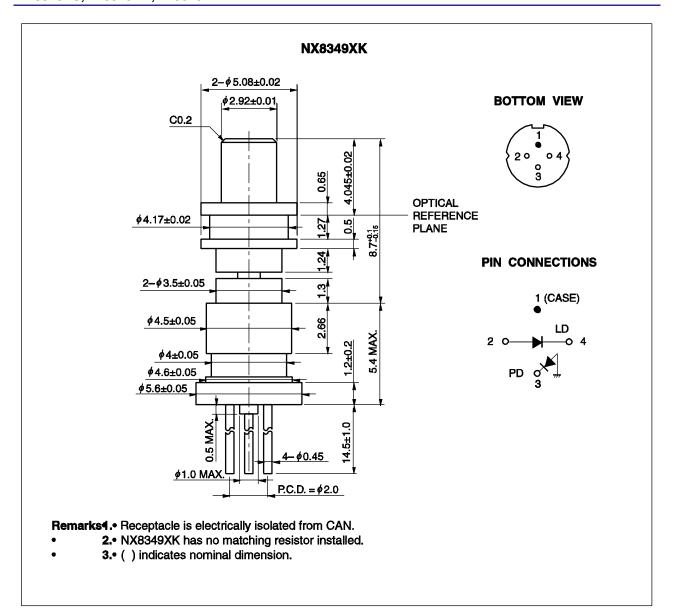




## PACKAGE DIMENSIONS (UNIT: mm)









## **ORDERING INFORMATION**

Part Number	Receptacle Type	Note
NX8349TS	LC, Electrically isolated, type 1	Differential input with short length flexible PCB,
NX8349YK	LC, Electrically isolated, type 2	without matching resistor
NX8349XK	LC, Electrically isolated, type 2	Differential input without flexible PCB, without matching resistor



## **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Ratings	Unit
Storage Temperature	T <sub>stg</sub>	−40 to +95	°C
Operating Case Temperature	T <sub>C</sub>	−5 to +95	°C
Forward Current of LD	I <sub>FLD</sub>	120	mA
Reverse Voltage of LD	$V_{RLD}$	2	V
Forward Current of PD	I <sub>FPD</sub>	10	mA
Reverse Voltage of PD	$V_{RPD}$	15	V
Soldering Temperature (Flexible Printed Circuit)	T <sub>sld</sub>	350 (10 sec.)	°C
Optical Output Power	Pf	5	mW

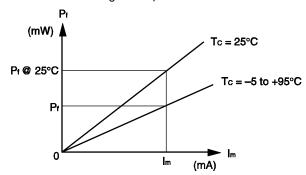


# ELECTRO-OPTICAL CHARACTERISTICS ( $T_c = -5$ to $+95^{\circ}$ C, BOL, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP	MAX.	Unit
Mean Optical Output Power	P <sub>f</sub>			-3		dBm
Peak Emission Wavelength	$\lambda_{p}$	CW, $P_f = -3 \text{ dBm}$	1 290		1 330	nm
Spectral Width	Δλ	CW, $P_f = -3$ dBm, 20 dB down			1	nm
Side Mode Suppression Ratio	SMSR	CW, $P_f = -3 \text{ dBm}$	35			dB
Threshold Current	I <sub>th</sub>	CW, T <sub>C</sub> = 25°C		8	15	mA
		CW	2		30	
Differential Efficiency	$\eta_{\sf d}$	CW, $P_f = -3$ dBm, $T_C = 25$ °C	0.020	0.033	0.040	W/A
		CW, $P_f = -3 \text{ dBm}$	0.012		0.060	
Temperature Dependence of Differential Efficiency	$arDelta\eta_{d}$	$\Delta \eta_{\rm d} = 10 \log \frac{\eta_{\rm d}}{\eta_{\rm d}  (@ 25^{\circ}\text{C})}$	-3.5		1.5	dB
Operation Voltage	V <sub>op</sub>	CW, $P_f = -3 \text{ dBm}$	0.5		2.2	V
Monitor Current	I <sub>m</sub>	CW, $P_f = -3 \text{ dBm}$	70		700	μA
Monitor Dark Current	I <sub>D</sub>	V <sub>R</sub> = 3.3 V, T <sub>C</sub> = 25°C			10	nA
		V <sub>R</sub> = 3.3 V			500	
Rise Time	t <sub>r</sub>	20-80% *1			50	ps
Fall Time	t <sub>f</sub>	20-80% *1			50	ps
Monitor PD Terminal	Ct	V <sub>R</sub> = 3.3 V, f = 1 MHz		6	20	pF
Capacitance						
Relative Intensity Noise	RIN	*1			-128	dB/Hz
Tracking Error <sup>*2</sup>	γ		-1.0		1.0	dB

Notes: \*1. 9.95/10.3/10.5 Gb/s, PRBS 2<sup>31</sup>–1, NRZ, Duty Cycle = 50%

\*2. Tracking Error: γ



$$\gamma = \left| 10 \log \frac{P_f}{P_f @ 25^{\circ}C} \right| [dB]$$



## **REFERENCE**

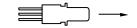
Document Name	Document No.	
Opto-Electronics Devices Pamphlet*1	PX10160E	

Notes: \*1. Published by the former NEC Electronics Corporation.

#### SAFETY INFORMATION ON THIS PRODUCT



#### **SEMICONDUCTOR LASER**



AVOID EXPOSURE-Invisible Laser Radiation is emitted from this aperture

Warning Laser Beam	A laser beam is emitted from this diode during operation.     The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight.     Do not look directly into the laser beam.     Avoid exposure to the laser beam, any reflected or collimated beam.
Caution GaAs Products	This product uses gallium arsenide (GaAs).  GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.
<b>Caution</b> Optical Fiber	A glass-fiber is attached on the product. Handle with care.     When the fiber is broken or damaged, handle carefully to avoid injury from the damaged part or fragments.

**Revision History** 

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		Description	
Rev.	Date	Page	Summary
1.00	Jul 26, 2010	_	First edition issued